

16-BIT DUAL-SUPPLY BUS TRANSCEIVER WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS

Check for Samples: [SN74AVCB164245-EP](#)

FEATURES

- Member of the Texas Instruments Widebus™ Family
- DOC™ Circuitry Dynamically Changes Output Impedance, Resulting in Noise Reduction Without Speed Degradation
- Dynamic Drive Capability Is Equivalent to Standard Outputs With I_{OH} and I_{OL} of ± 24 mA at 2.5-V V_{CC}
- Control Inputs V_{IH} and V_{IL} Levels Are Referenced to V_{CCB} Voltage
- If Either V_{CC} Input Is at GND, Both Ports Are in the High-Impedance State
- Overvoltage-Tolerant Inputs and Outputs Allow Mixed-Voltage-Mode Data Communications
- I_{off} Supports Partial-Power-Down Mode Operation
- Fully Configurable Dual-Rail Design Allows Each Port to Operate Over Full 1.4-V to 3.6-V Power-Supply Range
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 750-V Charged-Device Model (C101)

SUPPORTS DEFENSE, AEROSPACE, AND MEDICAL APPLICATIONS

- Controlled Baseline
- One Assembly and Test Site
- One Fabrication Site
- Available in Military (-55°C to 125°C) Temperature Ranges ⁽¹⁾
- Extended Product Life Cycle
- Extended Product-Change Notification
- Product Traceability

⁽¹⁾ Custom temperature ranges available

DESCRIPTION

This 16-bit (dual-octal) noninverting bus transceiver uses two separate configurable power-supply rails. The A port is designed to track V_{CCA} . V_{CCA} accepts any supply voltage from 1.4 V to 3.6 V. The B port is designed to track V_{CCB} . V_{CCB} accepts any supply voltage from 1.4 V to 3.6 V. This allows for universal low-voltage bidirectional translation between any of the 1.5-V, 1.8-V, 2.5-V, and 3.3-V voltage nodes.

The SN74AVCB164245 is designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the outputs so the buses are effectively isolated.

The SN74AVCB164245 is designed so that the control pins (1DIR, 2DIR, $1\overline{OE}$, and $2\overline{OE}$) are supplied by V_{CCB} .

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CCB} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down. If either V_{CC} input is at GND, both ports are in the high-impedance state.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Widebus, DOC are trademarks of Texas Instruments.

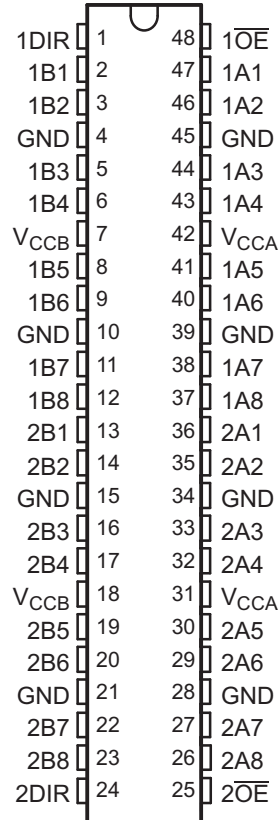
Table 1. ORDERING INFORMATION⁽¹⁾

| T _A | PACKAGE | ORDERABLE PART NUMBER | TOP-SIDE MARKING | VID NUMBER |
|----------------|-----------|-----------------------|--------------------|------------------|
| -55°C to 125°C | TSSOP-DGG | Reel of 2000 | CAVCB164245MDGGREP | V62/13602-01XE |
| | | Tube of 40 | CAVCB164245MDGGEP | |
| | | | AVCB164245M | V62/13602-01XE-T |

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

TERMINAL ASSIGNMENTS

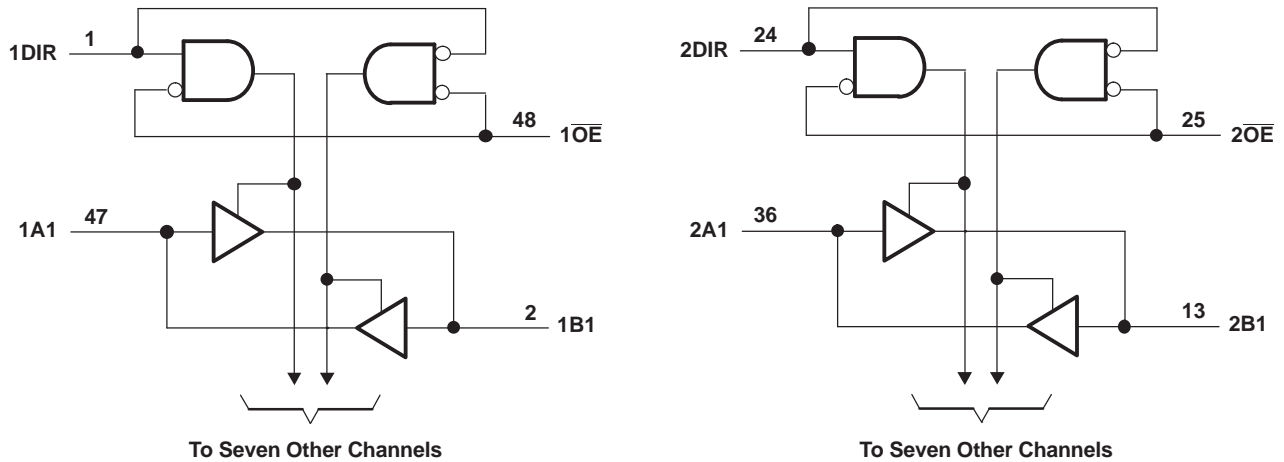
**DGG PACKAGE
(TOP VIEW)**



**FUNCTION TABLE
(EACH 8-BIT SECTION)**

| INPUTS | | OPERATION |
|-----------------|-----|-----------------|
| \overline{OE} | DIR | |
| L | L | B data to A bus |
| L | H | A data to B bus |
| H | X | Isolation |

Figure 1. LOGIC DIAGRAM (POSITIVE LOGIC)



Pin numbers shown are for the DGG and DGV packages.

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

| | | MIN | MAX | UNIT | |
|------------------------|---|---|------|-----------------|---|
| V_{CCA} V_{CCB} | Supply voltage range | -0.5 | 4.6 | V | |
| V_I | Input voltage range ⁽²⁾ | I/O ports (A port) | -0.5 | 4.6 | V |
| | | I/O ports (B port) | -0.5 | 4.6 | |
| | | Control inputs | -0.5 | 4.6 | |
| V_O | Voltage range applied to any output in the high-impedance or power-off state ⁽²⁾ | A port | -0.5 | 4.6 | V |
| | | B port | -0.5 | 4.6 | |
| V_O | Voltage range applied to any output in the high or low state ^{(2) (3)} | A port | -0.5 | $V_{CCA} + 0.5$ | V |
| | | B port | -0.5 | $V_{CCB} + 0.5$ | |
| I_{IK} | Input clamp current | $V_I < 0$ | -50 | mA | |
| I_{OK} | Output clamp current | $V_O < 0$ | -50 | mA | |
| I_O | Continuous output current | | ±50 | mA | |
| | | Continuous current through V_{CCA} , V_{CCB} , or GND | ±100 | | |
| T_J | Maximum junction temperature | | 150 | °C | |
| T_{stg} | Storage temperature range | -65 | 150 | °C | |

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current rating is observed.

THERMAL INFORMATION

| THERMAL METRIC ⁽¹⁾ | | SN74AVCB164245 | UNITS |
|-------------------------------|---|----------------|-------|
| | | DGG | |
| | | 48 PINS | |
| θ_{JA} | Junction-to-ambient thermal resistance ⁽²⁾ | 59.9 | °C/W |
| θ_{JcTop} | Junction-to-case (top) thermal resistance ⁽³⁾ | 13.9 | |
| θ_{JB} | Junction-to-board thermal resistance ⁽⁴⁾ | 27.1 | |
| ψ_{JT} | Junction-to-top characterization parameter ⁽⁵⁾ | 0.5 | |
| ψ_{JB} | Junction-to-board characterization parameter ⁽⁶⁾ | 26.8 | |
| θ_{JcBot} | Junction-to-case (bottom) thermal resistance ⁽⁷⁾ | N/A | |

- (1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, [SPRA953](#).
- (2) The junction-to-ambient thermal resistance under natural convection is obtained in a simulation on a JEDEC-standard, high-K board, as specified in JESD51-7, in an environment described in JESD51-2a.
- (3) The junction-to-case (top) thermal resistance is obtained by simulating a cold plate test on the package top. No specific JEDEC-standard test exists, but a close description can be found in the ANSI SEMI standard G30-88.
- (4) The junction-to-board thermal resistance is obtained by simulating in an environment with a ring cold plate fixture to control the PCB temperature, as described in JESD51-8.
- (5) The junction-to-top characterization parameter, ψ_{JT} , estimates the junction temperature of a device in a real system and is extracted from the simulation data for obtaining θ_{JA} , using a procedure described in JESD51-2a (sections 6 and 7).
- (6) The junction-to-board characterization parameter, ψ_{JB} , estimates the junction temperature of a device in a real system and is extracted from the simulation data for obtaining θ_{JA} , using a procedure described in JESD51-2a (sections 6 and 7).
- (7) The junction-to-case (bottom) thermal resistance is obtained by simulating a cold plate test on the exposed (power) pad. No specific JEDEC standard test exists, but a close description can be found in the ANSI SEMI standard G30-88.

RECOMMENDED OPERATING CONDITIONS⁽¹⁾⁽²⁾⁽³⁾
 $T_A = -55^\circ\text{C}$ to 125°C , over recommended input voltage range (unless otherwise noted)

| | | V_{CCI} | V_{CCO} | MIN | MAX | UNIT |
|---------------------|------------------------------------|--|------------------|-----------------------|-----------|------------------|
| V_{CCA} | Supply voltage | | | 1.4 | 3.6 | V |
| V_{CCB} | Supply voltage | | | 1.4 | 3.6 | V |
| V_{IH} | High-level input voltage | Data inputs | 1.4 V to 1.95 V | $V_{CCI} \times 0.65$ | | V |
| | | | 1.95 V to 2.7 V | 1.7 | | |
| | | | 2.7 V to 3.6 V | 2 | | |
| V_{IL} | Low-level input voltage | Data inputs | 1.4 V to 1.95 V | $V_{CCI} \times 0.35$ | | V |
| | | | 1.95 V to 2.7 V | 0.7 | | |
| | | | 2.7 V to 3.6 V | 0.8 | | |
| V_{IH} | High-level input voltage | Control inputs (referenced to V_{CCB}) | 1.4 V to 1.95 V | $V_{CCB} \times 0.65$ | | V |
| | | | 1.95 V to 2.7 V | 1.7 | | |
| | | | 2.7 V to 3.6 V | 2 | | |
| V_{IL} | Low-level input voltage | Control inputs (referenced to V_{CCB}) | 1.4 V to 1.95 V | $V_{CCB} \times 0.35$ | | V |
| | | | 1.95 V to 2.7 V | 0.7 | | |
| | | | 2.7 V to 3.6 V | 0.8 | | |
| V_I | Input voltage | | | 0 | 3.6 | V |
| V_O | Output voltage | Active state | | 0 | V_{CCO} | V |
| | | 3-state | | 0 | 3.6 | |
| I_{OH} | High-level output current | | 1.4 V to 1.6 V | -2 | | mA |
| | | | 1.65 V to 1.95 V | -4 | | |
| | | | 2.3 V to 2.7 V | -8 | | |
| | | | 3 V to 3.6 V | -12 | | |
| I_{OL} | Low-level output current | | 1.4 V to 1.6 V | 2 | | mA |
| | | | 1.65 V to 1.95 V | 4 | | |
| | | | 2.3 V to 2.7 V | 8 | | |
| | | | 3 V to 3.6 V | 12 | | |
| $\Delta t/\Delta v$ | Input transition rise or fall rate | | | | 5 | ns/V |
| T_A | Operating free-air temperature | | | -55 | 125 | $^\circ\text{C}$ |

(1) V_{CCI} is the V_{CC} associated with the data input port.

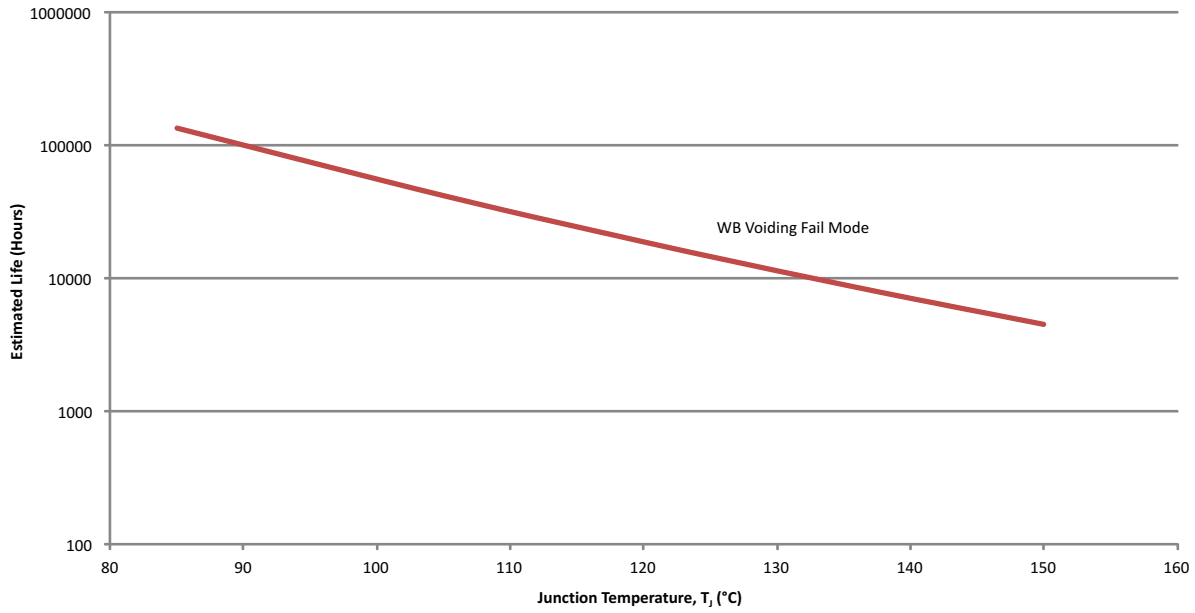
(2) V_{CCO} is the V_{CC} associated with the data output port.

(3) All unused data inputs of the device must be held at V_{CCI} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

ELECTRICAL CHARACTERISTICS⁽¹⁾⁽²⁾T_A = -55°C to 125°C, over recommended input voltage range (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | V _{CCA} | V _{CCB} | MIN | TYP ⁽³⁾ | MAX | UNIT | |
|--------------------------------|----------------|---|----------------------|------------------|------------------------|--------------------|------|-------|----|
| V _{OH} | | I _{OH} = -100 μA V _I = V _{IH} | 1.4 V to 3.6 V | 1.4 V to 3.6 V | V _{CCO} - 0.2 | | | V | |
| | | I _{OH} = -2 mA V _I = V _{IH} | 1.4 V | 1.4 V | 1.05 | | | | |
| | | I _{OH} = -4 mA V _I = V _{IH} | 1.65 V | 1.65 V | 1.2 | | | | |
| | | I _{OH} = -8 mA V _I = V _{IH} | 2.3 V | 2.3 V | 1.7 | | | | |
| | | I _{OH} = -12 mA V _I = V _{IH} | 3 V | 3 V | 2.2 | | | | |
| V _{OL} | | I _{OH} = 100 μA V _I = V _{IL} | 1.4 V to 3.6 V | 1.4 V to 3.6 V | | | 0.2 | V | |
| | | I _{OH} = 2 mA V _I = V _{IL} | 1.4 V | 1.4 V | | | 0.35 | | |
| | | I _{OH} = 4 mA V _I = V _{IL} | 1.65 V | 1.65 V | | | 0.45 | | |
| | | I _{OH} = 8 mA V _I = V _{IL} | 2.3 V | 2.3 V | | | 0.6 | | |
| | | I _{OH} = 12 mA V _I = V _{IL} | 3 V | 3 V | | | 0.75 | | |
| I _I | Control inputs | V _I = V _{CCB} or GND | 1.4 V to 3.6 V | 3.6 V | | | ±2.5 | μA | |
| I _{off} | A port | V _I or V _O = 0 to 3.6 V | 0 V | 0 to 3.6 V | | | ±10 | μA | |
| | B port | | 0 to 3.6 V | 0 V | | | ±10 | | |
| I _{OZ} ⁽⁴⁾ | A or B ports | V _O = V _{CCO} or GND, V _I = V _{CCI} or GND | OE = V _{IH} | 3.6 V | 3.6 V | | | ±12.5 | μA |
| | B port | | OE = don't care | 0 V | 3.6 V | | | ±12.5 | |
| | A port | | | 3.6 V | 0 V | | | ±12.5 | |
| I _{CCA} | | V _I = V _{CCI} or GND, I _O = 0 | 1.6 V | 1.6 V | | | 35 | μA | |
| | | | 1.95 V | 1.95 V | | | 35 | | |
| | | | 2.7 V | 2.7 V | | | 45 | | |
| | | | 0 V | 3.6 V | | | -50 | | |
| | | | 3.6 V | 0 V | | | 50 | | |
| | | | 3.6 V | 3.6 V | | | 50 | | |
| I _{CCB} | | V _I = V _{CCI} or GND, I _O = 0 | 1.6 V | 1.6 V | | | 35 | μA | |
| | | | 1.95 V | 1.95 V | | | 35 | | |
| | | | 2.7 V | 2.7 V | | | 45 | | |
| | | | 0 V | 3.6 V | | | 50 | | |
| | | | 3.6 V | 0 V | | | -50 | | |
| | | | 3.6 V | 3.6 V | | | 50 | | |
| C _i | Control inputs | V _I = 3.3 V or GND | 3.3 V | 3.3 V | | | 4 | pF | |
| C _{io} | A or B ports | V _O = 3.3 V or GND | 3.3 V | 3.3 V | | | 5 | pF | |

- (1) V_{CCO} is the V_{CC} associated with the output port.
- (2) V_{CCI} is the V_{CC} associated with the input port.
- (3) All typical values are at T_A = 25°C.
- (4) For I/O ports, the parameter I_{OZ} includes the input leakage current.



(1) See datasheet for absolute maximum and minimum recommended operating conditions.

Figure 2. SN74AVCB164245-EP Operating Life Derating Chart

Switching Characteristics

 $T_A = -40^\circ\text{C to } 85^\circ\text{C}$, $V_{CCA} = 1.5\text{ V} \pm 0.1\text{ V}$ (see)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CCB} = 1.5\text{ V} \pm 0.1\text{ V}$ | | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | | UNIT |
|-----------|-----------------|-------------|---|-----|--|-----|---|-----|---|-----|------|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| t_{pd} | A | B | 1.7 | 6.7 | 1.9 | 6.3 | 1.8 | 5.5 | 1.7 | 5.8 | ns |
| | B | A | 1.8 | 6.8 | 2.2 | 7.4 | 2.1 | 7.6 | 2.1 | 7.3 | |
| t_{en} | \overline{OE} | A | 2.5 | 8.4 | 2.4 | 7.4 | 2.1 | 5.2 | 1.9 | 4.2 | ns |
| | | B | 2.1 | 9 | 2.9 | 9.8 | 3.2 | 10 | 3 | 9.8 | |
| t_{dis} | \overline{OE} | A | 2.2 | 6.9 | 2.3 | 6.1 | 1.3 | 3.6 | 1.3 | 3 | ns |
| | | B | 2.1 | 7.1 | 2.3 | 6.4 | 1.7 | 5.1 | 1.6 | 4.8 | |

SWITCHING CHARACTERISTICS

 $T_A = -55^\circ\text{C to } 125^\circ\text{C}$, $V_{CCA} = 1.5\text{ V} \pm 0.1\text{ V}$ (see [Figure 4](#))

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CCB} = 1.5\text{ V} \pm 0.1\text{ V}$ | | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | | UNIT |
|-----------|-----------------|-------------|---|------|--|------|---|------|---|------|------|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| t_{pd} | A | B | | 12.7 | | 12.3 | | 11.5 | | 11.8 | ns |
| | B | A | | 12.8 | | 13.4 | | 13.6 | | 13.3 | |
| t_{en} | \overline{OE} | A | | 14.8 | | 13.9 | | 12.4 | | 11.9 | ns |
| | | B | | 15 | | 15.8 | | 16 | | 15.8 | |
| t_{dis} | \overline{OE} | A | | 12.9 | | 12.1 | | 9.6 | | 9 | ns |
| | | B | | 13.1 | | 12.4 | | 11.1 | | 10.8 | |

Switching Characteristics

 $T_A = -40^\circ\text{C to } 85^\circ\text{C}$, $V_{CCA} = 1.8\text{ V} \pm 0.15\text{ V}$ (see)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CCB} = 1.5\text{ V} \pm 0.1\text{ V}$ | | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | | UNIT |
|-----------|-----------------|-------------|---|-----|--|-----|---|-----|---|-----|------|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| t_{pd} | A | B | 1.7 | 6.7 | 1.8 | 6 | 1.7 | 4.7 | 1.6 | 4.3 | ns |
| | B | A | 1.4 | 5.5 | 1.8 | 6 | 1.8 | 5.8 | 1.8 | 5.5 | |
| t_{en} | \overline{OE} | A | 2.6 | 8.5 | 2.5 | 7.5 | 2.2 | 5.3 | 1.9 | 4.2 | ns |
| | | B | 1.8 | 7.6 | 2.6 | 7.7 | 2.6 | 7.6 | 2.6 | 7.4 | |
| t_{dis} | \overline{OE} | A | 2.3 | 7 | 2.3 | 6.1 | 1.3 | 3.6 | 1.3 | 3 | ns |
| | | B | 1.8 | 7 | 2.5 | 6.3 | 1.8 | 4.7 | 1.7 | 4.4 | |

SWITCHING CHARACTERISTICS

 $T_A = -55^\circ\text{C to } 125^\circ\text{C}$, $V_{CCA} = 1.8\text{ V} \pm 0.15\text{ V}$ (see [Figure 4](#))

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CCB} = 1.5\text{ V} \pm 0.1\text{ V}$ | | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | | UNIT |
|-----------|-----------------|-------------|---|------|--|------|---|------|---|------|------|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| t_{pd} | A | B | | 12.7 | | 12 | | 10.7 | | 10.3 | ns |
| | B | A | | 11.5 | | 12 | | 11.8 | | 11.5 | |
| t_{en} | \overline{OE} | A | | 14.5 | | 13.5 | | 12.1 | | 11.9 | ns |
| | | B | | 13.6 | | 13.7 | | 13.6 | | 13.4 | |
| t_{dis} | \overline{OE} | A | | 13 | | 12.1 | | 9.6 | | 9 | ns |
| | | B | | 13 | | 12.3 | | 10.7 | | 10.4 | |

Switching Characteristics

 $T_A = -40^{\circ}\text{C}$ to 85°C , $V_{CCA} = 2.5\text{ V} \pm 0.2\text{ V}$ (see)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CCB} = 1.5\text{ V} \pm 0.1\text{ V}$ | | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | | UNIT |
|-----------|-----------------|-------------|---|-----|--|-----|---|-----|---|-----|------|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| t_{pd} | A | B | 1.6 | 6 | 1.8 | 5.6 | 1.5 | 4 | 1.4 | 3.4 | ns |
| | B | A | 1.3 | 4.6 | 1.7 | 4.4 | 1.5 | 4 | 1.4 | 3.7 | |
| t_{en} | \overline{OE} | A | 3.1 | 8.5 | 2.5 | 7.5 | 2.2 | 5.3 | 1.9 | 4.2 | ns |
| | | B | 1.7 | 5.7 | 2.2 | 5.5 | 2.2 | 5.3 | 2.2 | 5.1 | |
| t_{dis} | \overline{OE} | A | 2.4 | 7 | 3 | 6.1 | 1.4 | 3.6 | 1.2 | 3 | ns |
| | | B | 1.2 | 5.8 | 1.9 | 5 | 1.4 | 3.6 | 1.3 | 3.3 | |

SWITCHING CHARACTERISTICS

 $T_A = -55^{\circ}\text{C}$ to 125°C , $V_{CCA} = 2.5\text{ V} \pm 0.2\text{ V}$ (see [Figure 4](#))

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CCB} = 1.5\text{ V} \pm 0.1\text{ V}$ | | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | | UNIT |
|-----------|-----------------|-------------|---|------|--|------|---|------|---|------|------|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| t_{pd} | A | B | | 12 | | 11.6 | | 10 | | 9.4 | ns |
| | B | A | | 10.6 | | 10.4 | | 10 | | 9.7 | |
| t_{en} | \overline{OE} | A | | 14.5 | | 13.5 | | 11.3 | | 10.2 | ns |
| | | B | | 11.7 | | 11.5 | | 11.3 | | 11.1 | |
| t_{dis} | \overline{OE} | A | | 13 | | 12.1 | | 9.6 | | 9 | ns |
| | | B | | 11.8 | | 11 | | 9.6 | | 9.3 | |

Switching Characteristics

 $T_A = -40^{\circ}\text{C}$ to 85°C , $V_{CCA} = 3.3\text{ V} \pm 0.3\text{ V}$ (see)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CCB} = 1.5\text{ V} \pm 0.1\text{ V}$ | | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | | UNIT |
|-----------|-----------------|-------------|---|-----|--|-----|---|-----|---|-----|------|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| t_{pd} | A | B | 1.5 | 5.9 | 1.7 | 5.4 | 1.5 | 3.7 | 1.4 | 3.1 | ns |
| | B | A | 1.3 | 4.5 | 1.6 | 3.8 | 1.5 | 3.3 | 1.4 | 3.1 | |
| t_{en} | \overline{OE} | A | 2.6 | 8.3 | 2.5 | 7.4 | 2.2 | 5.2 | 1.9 | 4.1 | ns |
| | | B | 1.6 | 4.9 | 2 | 4.5 | 2 | 4.3 | 1.9 | 4.1 | |
| t_{dis} | \overline{OE} | A | 2.3 | 7 | 3 | 6 | 1.3 | 3.5 | 1.2 | 3.5 | ns |
| | | B | 1.3 | 6.9 | 2.1 | 5.5 | 1.6 | 3.8 | 1.5 | 3.5 | |

SWITCHING CHARACTERISTICS

 $T_A = -55^{\circ}\text{C}$ to 125°C , $V_{CCA} = 3.3\text{ V} \pm 0.3\text{ V}$ (see [Figure 4](#))

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CCB} = 1.5\text{ V} \pm 0.1\text{ V}$ | | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | | UNIT |
|-----------|-----------------|-------------|---|------|--|------|---|------|---|------|------|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| t_{pd} | A | B | | 11.9 | | 11.4 | | 9.7 | | 9.1 | ns |
| | B | A | | 10.5 | | 9.8 | | 9.3 | | 9.1 | |
| t_{en} | \overline{OE} | A | | 14.3 | | 13.4 | | 11.2 | | 10.1 | ns |
| | | B | | 11.3 | | 10.5 | | 10.3 | | 10.1 | |
| t_{dis} | \overline{OE} | A | | 13 | | 12 | | 9.5 | | 9.5 | ns |
| | | B | | 12.9 | | 11.5 | | 9.8 | | 9.5 | |

OPERATING CHARACTERISTICS

V_{CCA} and $V_{CCB} = 3.3\text{ V}$, $T_A = 25^\circ\text{C}$

| PARAMETER | | TEST CONDITIONS | TYP | UNIT |
|----------------------------|---|------------------|-----|------|
| C_{pdA} (V_{CCA}) | Power dissipation capacitance per transceiver, A-port input, B-port output | Outputs enabled | 14 | pF |
| | | Outputs disabled | 7 | |
| | Power dissipation capacitance per transceiver, B-port input, A-port output | Outputs enabled | 20 | |
| | | Outputs disabled | 7 | |
| C_{pdB} (V_{CCB}) | Power dissipation capacitance per transceiver, A-port input, B-port output | Outputs enabled | 20 | pF |
| | | Outputs disabled | 7 | |
| | Power dissipation capacitance per transceiver, B-port input, A-port output | Outputs enabled | 14 | |
| | | Outputs disabled | 7 | |

OUTPUT DESCRIPTION

The DOC™ circuitry is implemented, which, during the transition, initially lowers the output impedance to effectively drive the load and, subsequently, raises the impedance to reduce noise. Figure 1 shows typical V_{OL} vs I_{OL} and V_{OH} vs I_{OH} curves to illustrate the output impedance and drive capability of the circuit. At the beginning of the signal transition, the DOC circuit provides a maximum dynamic drive that is equivalent to a high-drive standard-output device. For more information, refer to the TI application reports, *AVC Logic Family Technology and Applications*, literature number SCEA006, and *Dynamic Output Control (DOC™) Circuitry Technology and Applications*, literature number SCEA009.

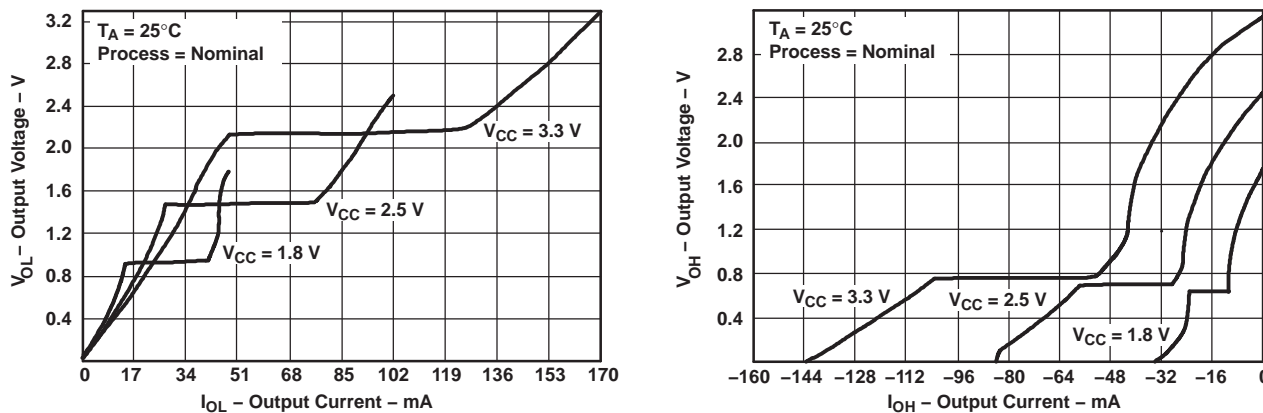
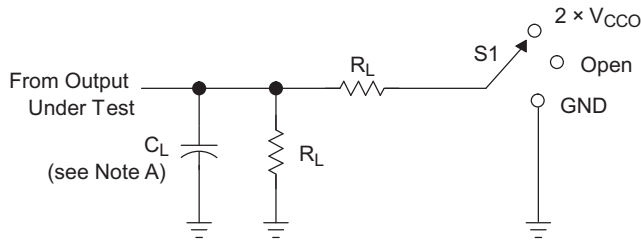


Figure 3. Typical Output Voltage vs Output Current

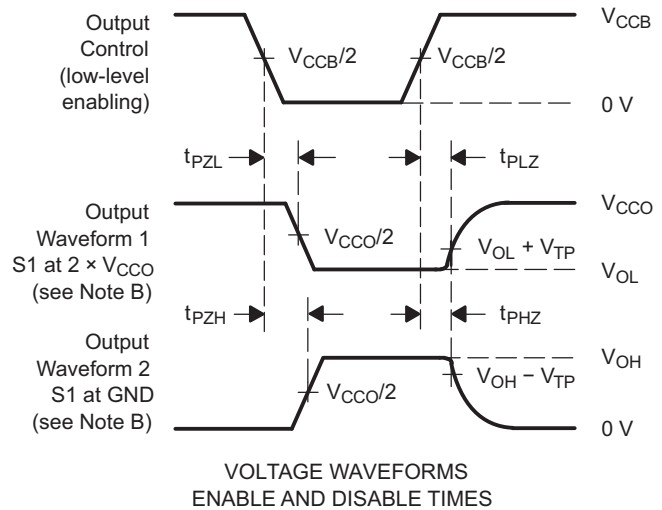
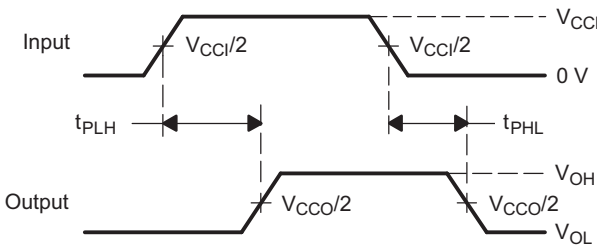
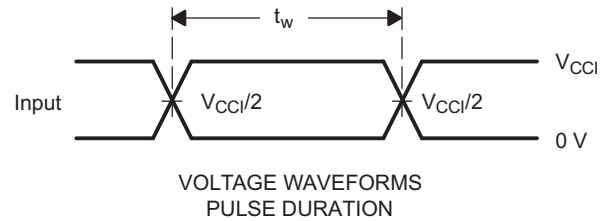
PARAMETER MEASUREMENT INFORMATION



LOAD CIRCUIT

| TEST | S1 |
|-------------------|--------------------|
| t_{pd} | Open |
| t_{PLZ}/t_{PZL} | $2 \times V_{CCO}$ |
| t_{PHZ}/t_{PZH} | GND |

| V_{CCO} | C_L | R_L | V_{TP} |
|----------------------------------|-------|--------------|----------|
| $1.5\text{ V} \pm 0.1\text{ V}$ | 15 pF | 500 Ω | 0.1 V |
| $1.8\text{ V} \pm 0.15\text{ V}$ | 30 pF | 500 Ω | 0.15 V |
| $2.5\text{ V} \pm 0.2\text{ V}$ | 30 pF | 500 Ω | 0.15 V |
| $3.3\text{ V} \pm 0.3\text{ V}$ | 30 pF | 500 Ω | 0.3 V |



- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: PRR 10 MHz, $Z_O = 50\ \Omega$, $dv/dt \geq 1\text{ V/ns}$.
 D. The outputs are measured one at a time, with one transition per measurement.
 E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 F. t_{PZL} and t_{PZH} are the same as t_{en} .
 G. t_{PLH} and t_{PHL} are the same as t_{pd} .
 H. V_{CCI} is the V_{CC} associated with the input port.
 I. V_{CCO} is the V_{CC} associated with the output port.

Figure 4. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|------------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| CAVCB164245MDGGEP | Active | Production | TSSOP (DGG) 48 | 40 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | -55 to 125 | AVCB164245M |
| CAVCB164245MDGGREP | Active | Production | TSSOP (DGG) 48 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -55 to 125 | AVCB164245M |
| V62/13602-01XE | Active | Production | TSSOP (DGG) 48 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -55 to 125 | AVCB164245M |
| V62/13602-01XE-T | Active | Production | TSSOP (DGG) 48 | 40 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | -55 to 125 | AVCB164245M |

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF SN74AVCB164245-EP :

- Catalog : [SN74AVCB164245](#)
- Automotive : [SN74AVCB164245-Q1](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CAVCB164245MDGGREP | TSSOP | DGG | 48 | 2000 | 330.0 | 24.4 | 8.6 | 13.0 | 1.8 | 12.0 | 24.0 | Q1 |

TAPE AND REEL BOX DIMENSIONS

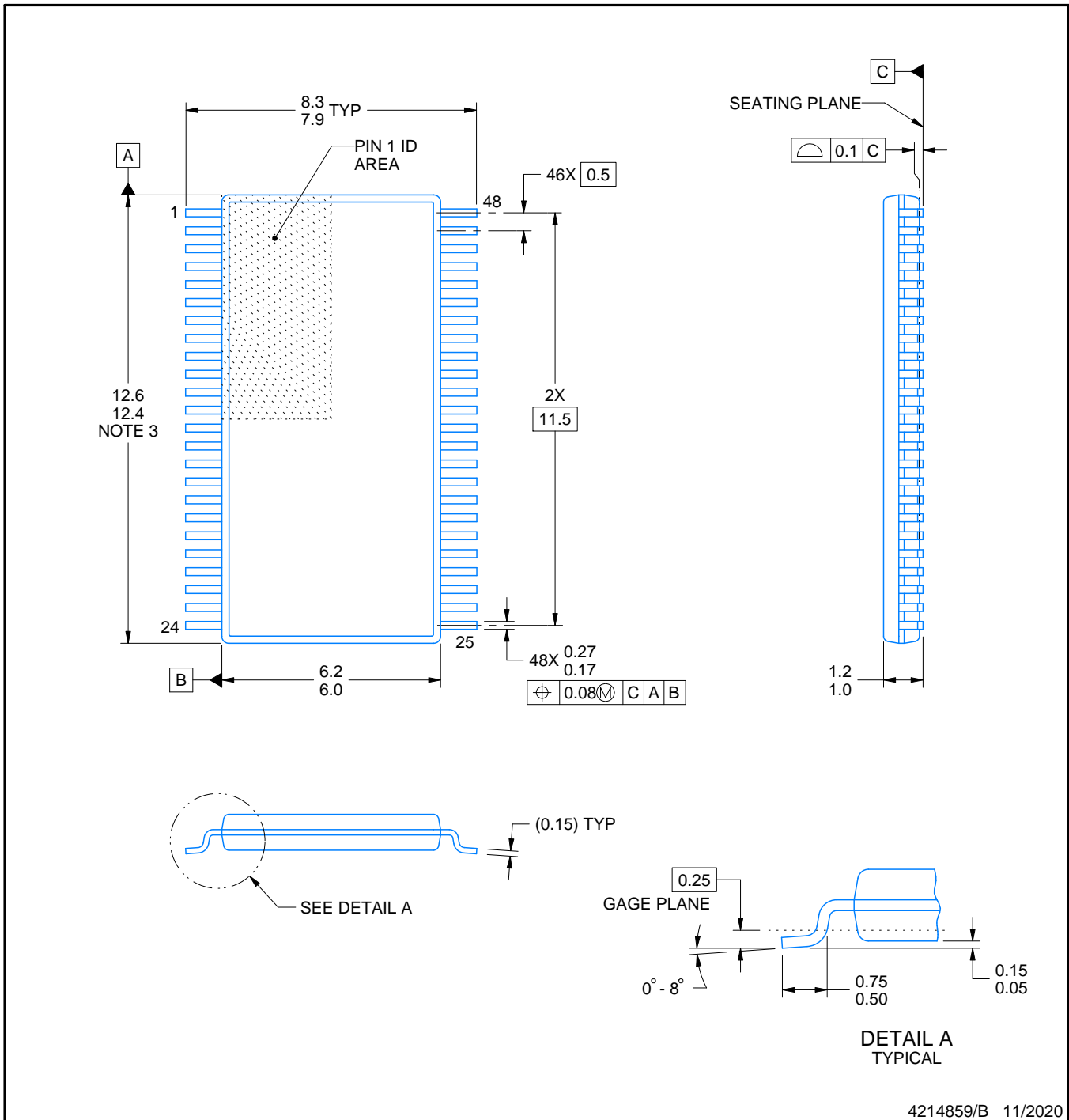

*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|--------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CAVCB164245MDGGREP | TSSOP | DGG | 48 | 2000 | 356.0 | 356.0 | 45.0 |

TUBE


*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|-------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| CAVCB164245MDGGEP | DGG | TSSOP | 48 | 40 | 530 | 11.89 | 3600 | 4.9 |
| V62/13602-01XE-T | DGG | TSSOP | 48 | 40 | 530 | 11.89 | 3600 | 4.9 |



4214859/B 11/2020

NOTES:

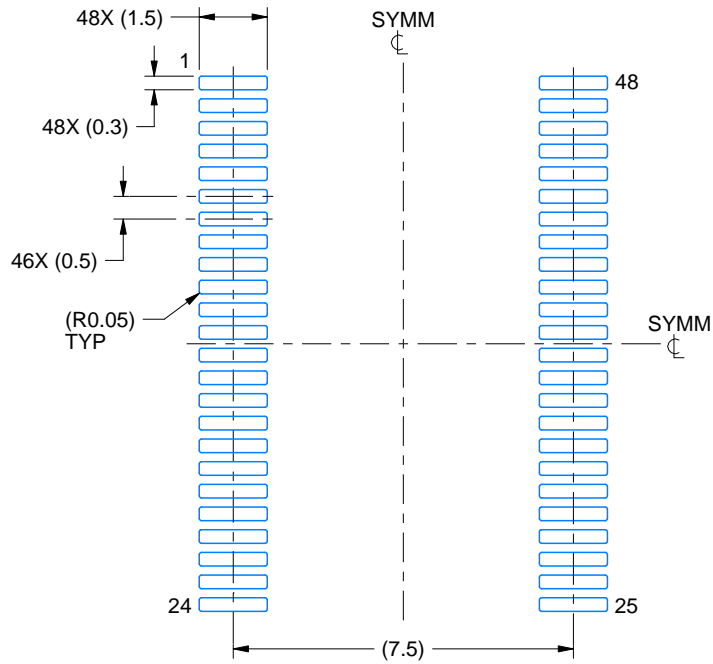
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. Reference JEDEC registration MO-153.

EXAMPLE BOARD LAYOUT

DGG0048A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE
SCALE:6X



SOLDER MASK DETAILS

4214859/B 11/2020

NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DGG0048A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:6X

4214859/B 11/2020

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you fully indemnify TI and its representatives against any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#), [TI's General Quality Guidelines](#), or other applicable terms available either on [ti.com](#) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products. Unless TI explicitly designates a product as custom or customer-specified, TI products are standard, catalog, general purpose devices.

TI objects to and rejects any additional or different terms you may propose.

Copyright © 2025, Texas Instruments Incorporated

Last updated 10/2025